

SEMiX453GB12E4s



Trench IGBT Modules

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Features

- Homogeneous Si
- Trench = Trenchgate technology
- $V_{CE(sat)}$ with positive temperature coefficient
- High short circuit capability
- UL recognized, file no. E63532

Typical Applications*

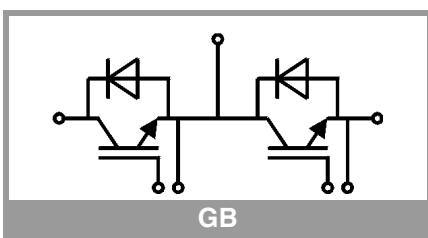
- AC inverter drives
- UPS
- Electronic Welding

Remarks

- Case temperature limited to $T_C=125^\circ\text{C}$ max.
- Product reliability results are valid for $T_j=150^\circ\text{C}$
- Dynamic values apply to the following combination of resistors:
 $R_{Gon,\text{main}} = 1,0 \Omega$
 $R_{Goff,\text{main}} = 1,0 \Omega$
 $R_{G,X} = 2,2 \Omega$
 $R_{E,X} = 0,5 \Omega$

Absolute Maximum Ratings		Values	Unit
Symbol	Conditions		
IGBT			
V_{CES}	$T_j = 25^\circ\text{C}$	1200	V
I_C	$T_j = 175^\circ\text{C}$	683	A
		526	A
I_{Cnom}		450	A
I_{CRM}	$I_{CRM} = 3 \times I_{Cnom}$	1350	A
V_{GES}		-20 ... 20	V
t_{psc}	$V_{CC} = 800 \text{ V}$ $V_{GE} \leq 20 \text{ V}$ $V_{CES} \leq 1200 \text{ V}$	10	μs
T_j		-40 ... 175	$^\circ\text{C}$
Inverse diode			
I_F	$T_j = 175^\circ\text{C}$	544	A
		407	A
I_{Fnom}		450	A
I_{FRM}	$I_{FRM} = 3 \times I_{Fnom}$	1350	A
I_{FSM}	$t_p = 10 \text{ ms}, \sin 180^\circ, T_j = 25^\circ\text{C}$	2430	A
T_j		-40 ... 175	$^\circ\text{C}$
Module			
$I_{t(\text{RMS})}$	$T_{\text{terminal}} = 80^\circ\text{C}$	600	A
T_{stg}		-40 ... 125	$^\circ\text{C}$
V_{isol}	AC sinus 50Hz, $t = 1 \text{ min}$	4000	V

Characteristics		min.	typ.	max.	Unit
Symbol	Conditions				
IGBT					
$V_{CE(\text{sat})}$	$I_C = 450 \text{ A}$ $V_{GE} = 15 \text{ V}$ chiplevel	$T_j = 25^\circ\text{C}$	1.8	2.05	V
		$T_j = 150^\circ\text{C}$	2.2	2.4	V
V_{CE0}		$T_j = 25^\circ\text{C}$	0.8	0.9	V
		$T_j = 150^\circ\text{C}$	0.7	0.8	V
r_{CE}	$V_{GE} = 15 \text{ V}$	$T_j = 25^\circ\text{C}$	2.2	2.6	$\text{m}\Omega$
		$T_j = 150^\circ\text{C}$	3.3	3.6	$\text{m}\Omega$
$V_{GE(\text{th})}$	$V_{GE}=V_{CE}, I_C = 18 \text{ mA}$	5	5.8	6.5	V
I_{CES}	$V_{GE} = 0 \text{ V}$ $V_{CE} = 1200 \text{ V}$	$T_j = 25^\circ\text{C}$	0.1	0.3	mA
		$T_j = 150^\circ\text{C}$			mA
C_{ies}	$V_{CE} = 25 \text{ V}$	$f = 1 \text{ MHz}$	27.9		nF
C_{oes}	$V_{GE} = 0 \text{ V}$	$f = 1 \text{ MHz}$	1.74		nF
C_{res}		$f = 1 \text{ MHz}$	1.53		nF
Q_G	$V_{GE} = -8 \text{ V} \dots +15 \text{ V}$		2550		nC
R_{Gint}	$T_j = 25^\circ\text{C}$		1.67		Ω
$t_{d(on)}$	$V_{CC} = 600 \text{ V}$	$T_j = 150^\circ\text{C}$	336		ns
t_r	$I_C = 450 \text{ A}$	$T_j = 150^\circ\text{C}$	80		ns
E_{on}	$V_{GE} = \pm 15 \text{ V}$	$T_j = 150^\circ\text{C}$	45		mJ
$t_{d(off)}$	$R_{G\text{ on}} = 1.9 \Omega$	$T_j = 150^\circ\text{C}$	615		ns
t_f	$R_{G\text{ off}} = 1.9 \Omega$	$T_j = 150^\circ\text{C}$	130		ns
E_{off}	$\text{di}/\text{dt}_{\text{on}} = 4000 \text{ A}/\mu\text{s}$ $\text{di}/\text{dt}_{\text{off}} = 5000 \text{ A}/\mu\text{s}$	$T_j = 150^\circ\text{C}$	66.5		mJ
$R_{\text{th(j-c)}}$	per IGBT		0.065		K/W



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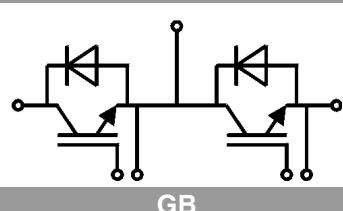
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 $R_{GX} = 2,2 \Omega$
 $R_{EX} = 0,5 \Omega$

Characteristics		Symbol	Conditions	min.	typ.	max.	Unit						
Inverse diode													
$V_F = V_{EC}$													
$I_F = 450 \text{ A}$	$T_j = 25^\circ\text{C}$		$V_{GE} = 0 \text{ V}$ chip	2.1	2.46	V							
	$T_j = 150^\circ\text{C}$					2.1	2.4						
V_{FO}	$T_j = 25^\circ\text{C}$			1.1	1.3	1.5	V						
	$T_j = 150^\circ\text{C}$			0.7	0.9	1.1	V						
r_F	$T_j = 25^\circ\text{C}$			1.4	1.9	2.1	$\text{m}\Omega$						
	$T_j = 150^\circ\text{C}$			2.2	2.6	2.8	$\text{m}\Omega$						
I_{RRM}	$I_F = 450 \text{ A}$		$T_j = 150^\circ\text{C}$		350		A						
Q_{rr}	$di/dt_{off} = 5000 \text{ A}/\mu\text{s}$		$T_j = 150^\circ\text{C}$		70		μC						
E_{rr}	$V_{GE} = -15 \text{ V}$		$T_j = 150^\circ\text{C}$		28		mJ						
$R_{th(j-c)}$	per diode					0.11	K/W						
Module													
L_{CE}					20		nH						
$R_{CC'+EE'}$	res., terminal-chip		$T_C = 25^\circ\text{C}$		0.7		$\text{m}\Omega$						
			$T_C = 125^\circ\text{C}$		1		$\text{m}\Omega$						
$R_{th(c-s)}$	per module				0.04		K/W						
M_s	to heat sink (M5)			3	5		Nm						
M_t	to terminals (M6)			2.5	5		Nm						
w						300	g						
Temperatur Sensor													
R_{100}	$T_c=100^\circ\text{C}$ ($R_{25}=5 \text{ k}\Omega$)			493 ± 5%			Ω						
$B_{100/125}$	$R_{(T)}=R_{100}\exp[B_{100/125}(1/T-1/T_{100})]; T[\text{K}]$; $\pm 2\%$			3550			K						



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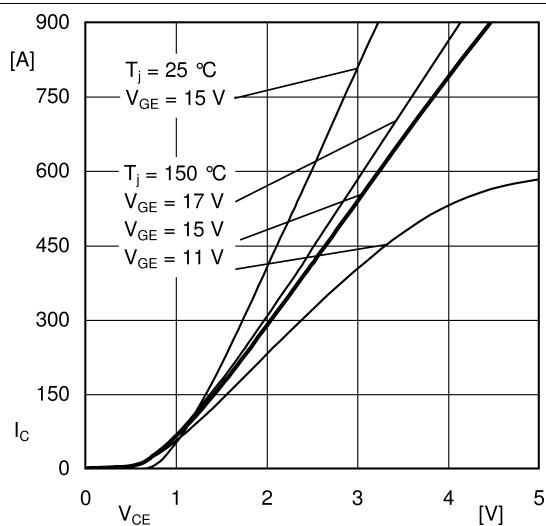


Fig. 1: Typ. output characteristic, inclusive $R_{CC} + EE'$

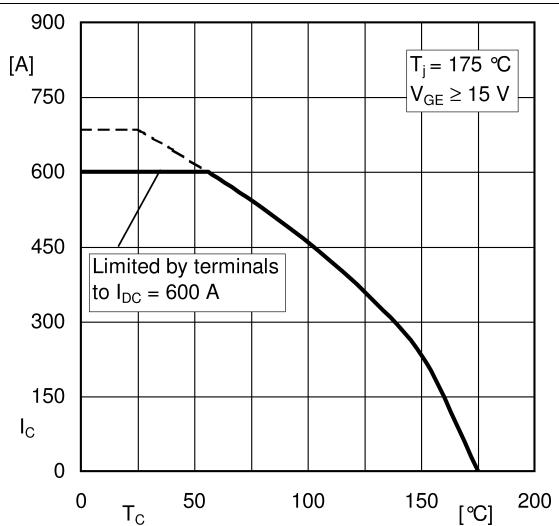


Fig. 2: Rated current vs. temperature $I_C = f(T_C)$

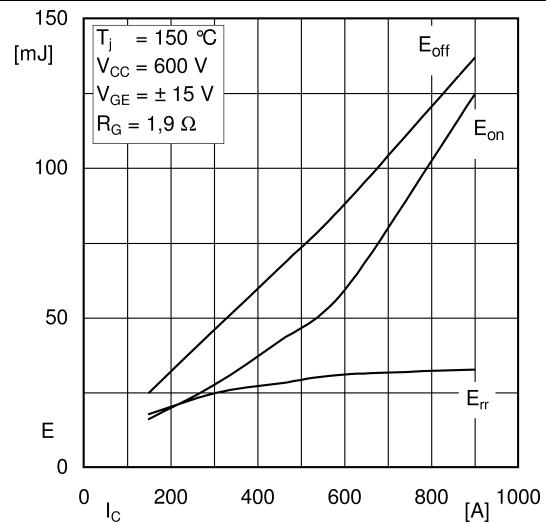


Fig. 3: Typ. turn-on /-off energy = f (I_C)

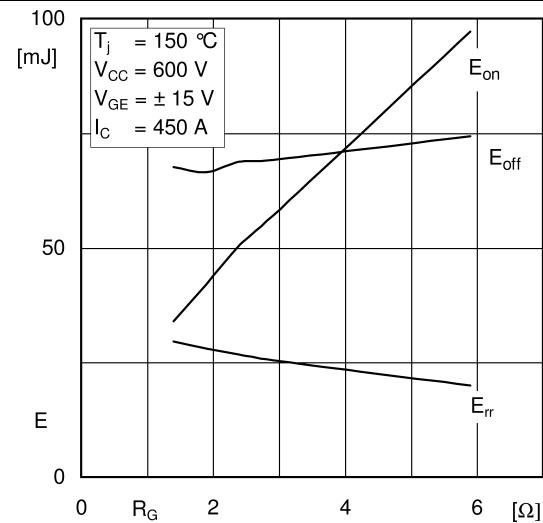


Fig. 4: Typ. turn-on /-off energy = f (R_G)

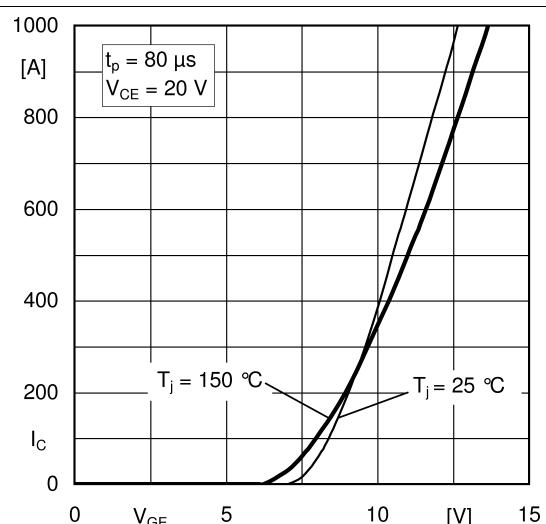


Fig. 5: Typ. transfer characteristic

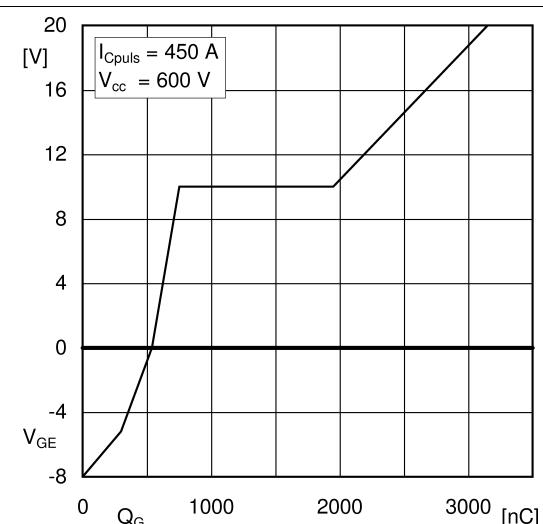


Fig. 6: Typ. gate charge characteristic

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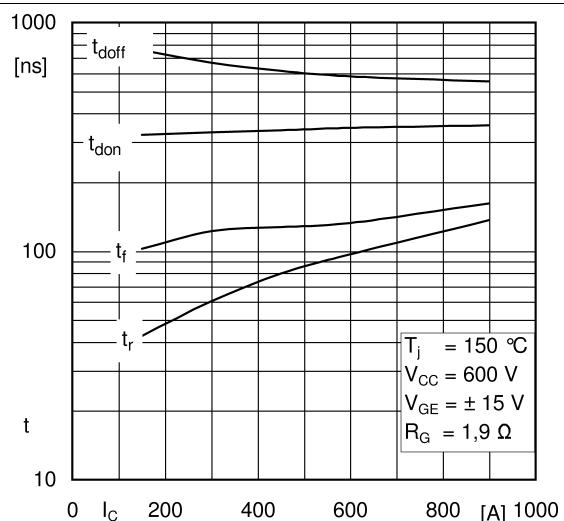


Fig. 7: Typ. switching times vs. I_C

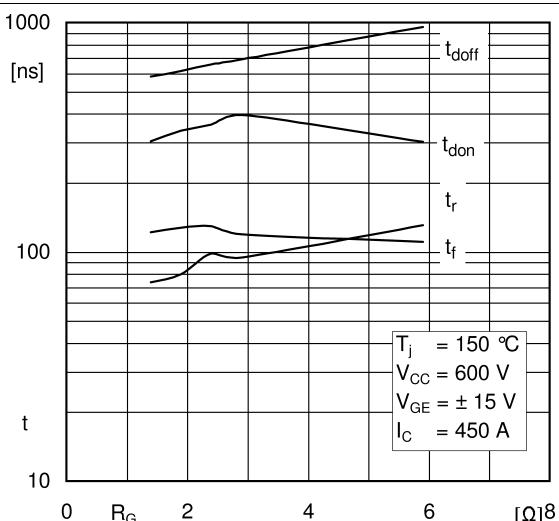


Fig. 8: Typ. switching times vs. gate resistor R_G

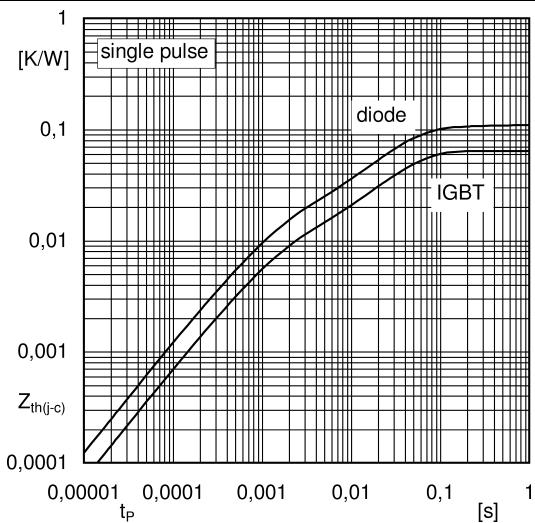


Fig. 9: Typ. transient thermal impedance

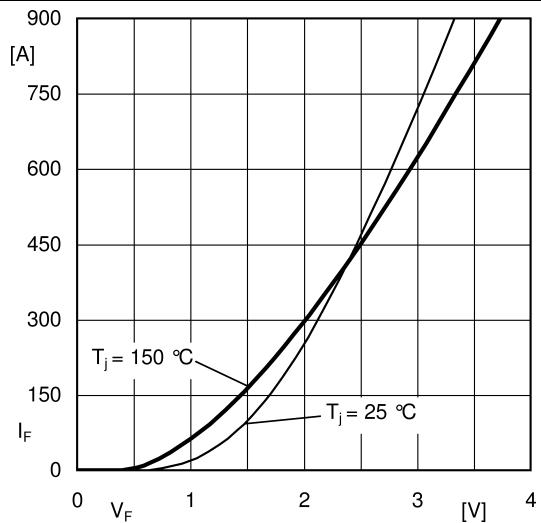


Fig. 10: Typ. CAL diode forward charact., incl. R_{CC+EE}

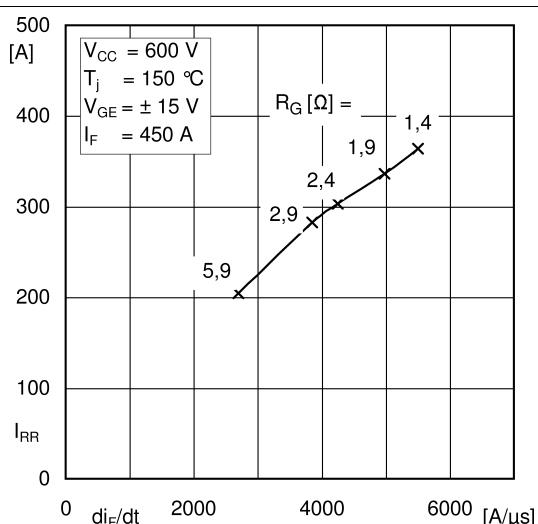


Fig. 11: Typ. CAL diode peak reverse recovery current

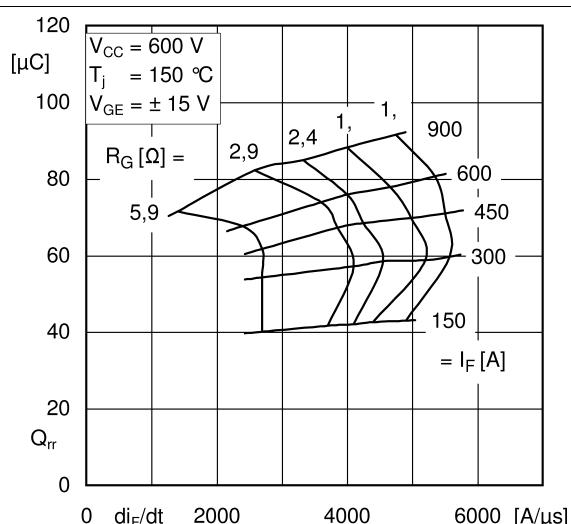
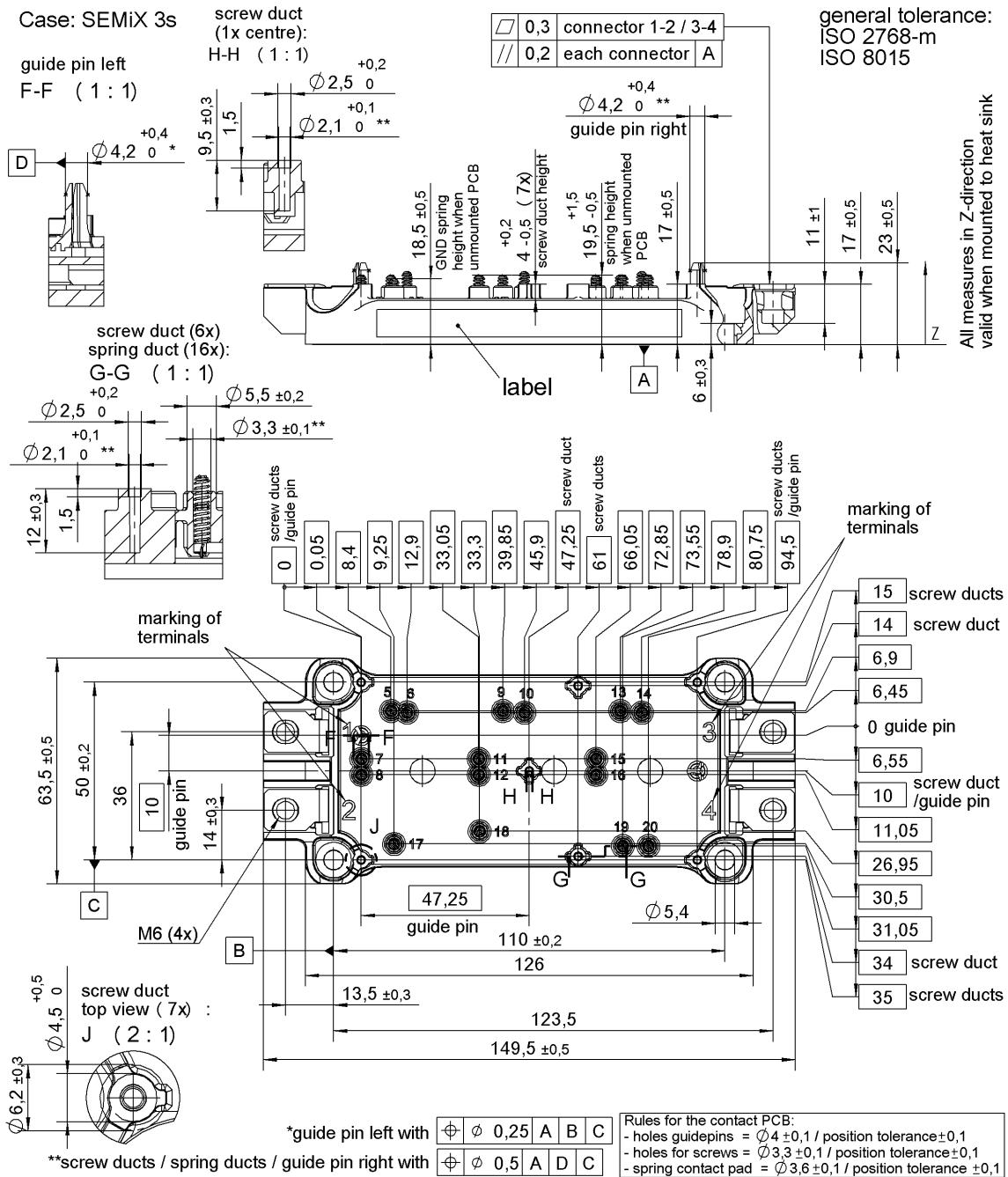
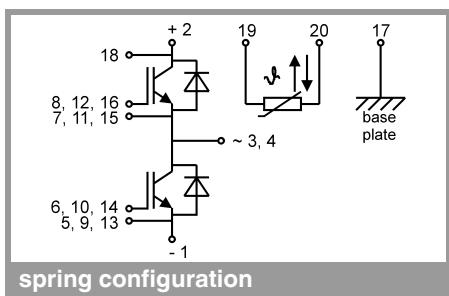


Fig. 12: Typ. CAL diode recovery charge

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SEMiX 3s



This is an electrostatic discharge sensitive device (ESDS), international standard IEC 60747-1, Chapter IX

* The specifications of our components may not be considered as an assurance of component characteristics. Components have to be tested for the respective application. Adjustments may be necessary. The use of SEMIKRON products in life support appliances and systems is subject to prior specification and written approval by SEMIKRON. We therefore strongly recommend prior consultation of our staff.